L Number	Hits	Search Text	DB	Time stamp
1	2139	dmd or (digital adj micro adj mirror adj	USPAT;	2002/03/27 15:25
]		device)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	1590	(dmd or (digital adj micro adj mirror adj	USPAT;	2002/03/27 15:36
		device)) and (method or process or	US-PGPUB;	
1		manufacture)	EPO; JPO;	
			DERWENT;	
1			IBM TDB	
4	37		USPAT;	2002/03/27 15:37
1		device)) and wafer and (chip same mirror)	US-PGPUB;	
]			EPO; JPO;	
			DERWENT;	
,			IBM TDB	1
2	69	(USPAT;	2002/03/27 16:59
1		device)) and (metal\$ with (wafer or chip))	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
5	8330	mirror with (wafer or chip)	USPAT;	2002/03/27 17:00
1			US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	
			IBM TDB	
6	1507	(mirror with (wafer or chip)) and	USPAT;	2002/03/27 17:02
1		@pd>20001005	US-PGPUB;	
1			EPO; JPO;	
!			DERWENT;]
1			IBM TDB	
7	300	(mirror with (wafer or chip)) and (pad	USPAT;	2002/03/27 17:03
1		with chip)	US-PGPUB;	
[EPO; JPO;	
			DERWENT;	
	40.		IBM TDB	0000/03/03 13 05
8	434	(dmd or (digital adj micro adj mirror adj	USPAT;	2002/03/27 17:05
		device)) and (diec or singulate or cut or	US-PGPUB;	<u> </u>
		break)	EPO; JPO;	
			DERWENT;	
	46	(/dmd on /digital add miana add minner add		2002/03/27 17:05
9	46	((dmd or (digital adj micro adj mirror adj	USPAT; US-PGPUB;	2002/03/2/ 1/:05
		device)) and (diec or singulate or cut or	EPO; JPO;	
		break)) and photoresist	DERWENT;	
			IBM TDB	
10	6	((dmd or (digital adj micro adj mirror adj	USPAT;	2002/03/27 17:05
10	0	device)) and (diec or singulate or cut or	US-PGPUB;	2002/03/2/ 17:03
1		break)) and (remove with photoresist)	EPO; JPO;	
		preary) and (remove wren brocorestse)	DERWENT;	
!			IBM TDB	
1			TOU TOD	1